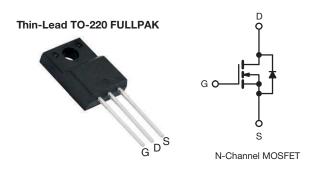
**Vishay Siliconix** 

VISHAY, www.vishay.com

## **EL Series Power MOSFET**



PRODUCT SUMMARY					
V <sub>DS</sub> (V) at T <sub>J</sub> max.	650				
R <sub>DS(on)</sub> typ. (Ω) at 25 °C	$V_{GS} = 10 \text{ V}$	0.155			
Q <sub>g</sub> max. (nC)	82				
Q <sub>gs</sub> (nC)	20				
Q <sub>gd</sub> (nC)	13				
Configuration	Single				

#### **FEATURES**

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (C<sub>iss</sub>)
- Reduced switching and conduction losses
- Ultra low gate charge (Qg)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

### **APPLICATIONS**

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
- Welding
- Induction heating
- Motor drives
- Battery chargers
- Renewable energy
- Solar (PV inverters)

ORDERING INFORMATION	
Package	Thin-lead TO-220 FULLPAK
Lead (Pb)-free and halogen-free	SiHA22N60AEL-GE3

<b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_C = 25 \degree C$ , unless otherwise noted)						
PARAMETER	SYMBOL	LIMIT	UNIT			
Drain-source voltage	V <sub>DS</sub>	600	V			
Gate-source voltage	V <sub>GS</sub>	± 30	v			
Continuous drain surrant $(T_{\rm e} = 150 ^{\circ}{\rm C})^{\circ}$	$V_{GS} \text{ at } 10 \text{ V} \qquad \frac{T_{C} = 25 \text{ °C}}{T_{C} = 100 \text{ °C}}$	- I <sub>D</sub>	21			
Continuous drain current ( $T_J = 150 \text{ °C}$ ) <sup>e</sup>	$V_{GS}$ at 10 V $T_{C} = 100 \text{ °C}$		13	A		
Pulsed drain current <sup>a</sup>	I <sub>DM</sub>	48				
Linear derating factor			1.7	W/°C		
Single pulse avalanche energy <sup>b</sup>		E <sub>AS</sub>	183	mJ		
Maximum power dissipation		PD	35	W		
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C		
Reverse diode dv/dt d		dv/dt	50	V/ns		
Soldering recommendations (peak temperature) <sup>c</sup>	For 10 s		260	°C		

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b.  $V_{DD}$  = 120 V, starting  $T_J$  = 25 °C, L = 28.2 mH,  $R_g$  = 25  $\Omega,$   $I_{AS}$  = 3.6 A

c. 1.6 mm from case

d.  $I_{SD} \leq I_D, \, di/dt$  = 100 A/µs, starting  $T_J$  = 25  $^\circ C$ 

e. Limited by maximum junction temperature

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COMPLIANT

HALOGEN

FREE



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THERMAL RESISTANCE RAT	INGS							
PARAMETER	SYMBOL	TYP. MAX.		κ.	UNIT			
Maximum junction-to-ambient	R <sub>thJA</sub>	- 65			°C/M			
Maximum junction-to-case (drain)	R <sub>thJC</sub>	-	3.6	3.6		°C/W		
<b>SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C, u	unless otherwi	se noted)						
PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNI	
Static								
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub> =	= 0 V, I <sub>D</sub> = 250 μA	600	-	-	V	
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I <sub>D</sub> = 1 mA	-	0.68	-	V/°C	
Gate-source threshold Voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> = 250 μΑ	2.0	-	4.0	V	
	1	$V_{GS} = \pm 20 \text{ V}$		-	-	± 100	nA	
Gate-source leakage	I <sub>GSS</sub>	$V_{GS} = \pm 30 \text{ V}$		-	-	± 1	μA	
Zero gate voltage drain current	I <sub>DSS</sub>	$V_{DS} = 600 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$		-	-	1	μA	
		$V_{DS} = 480 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 ^{\circ}\text{C}$		-	-	10		
Drain-source on-state resistance	R <sub>DS(on)</sub>	$V_{GS} = 10 V$	I <sub>D</sub> = 11 A	-	0.155	0.180	Ω	
Forward transconductance	9 <sub>fs</sub>	V <sub>DS</sub> = 8 V, I <sub>D</sub> = 11 A		-	16	-	S	
Dynamic	•	•			•	•		
Input capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 100 V,		-	1757	-	-	
Output capacitance	C <sub>oss</sub>			-	74	-		
Reverse transfer capacitance	C <sub>rss</sub>		f = 1 MHz		6	-		
Effective output capacitance, energy related <sup>a</sup>	C <sub>o(er)</sub>				48	-	pF	
Effective output capacitance, time related <sup>b</sup>	C <sub>o(tr)</sub>	$V_{DS} = 0 V$ to 480 V, $V_{GS} = 0 V$		-	257	-		
Total gate charge	Qq			-	41	82	-	
Gate-source charge	Q <sub>qs</sub>	V <sub>GS</sub> = 10 V	V <sub>GS</sub> = 10 V I <sub>D</sub> = 11 A, V <sub>DS</sub> = 480 V	-	10	-	nC	
			-		1 10	1		
Gate-drain charge	Q <sub>qd</sub>			-	13	-		
Gate-drain charge Turn-on delay time	Q <sub>gd</sub> t <sub>d(on)</sub>			-	13 27	- 54		
ě	Q <sub>gd</sub> t <sub>d(on)</sub> t <sub>r</sub>	- - - Voo =	= 480 V, I <sub>D</sub> = 11 A,	-		- 54 48	ns	

Fall time	t <sub>f</sub>		-	28	56		
Gate input resistance	R <sub>g</sub>	f = 1 MHz, open drain	3.6	7.2	14.4	Ω	
Drain-Source Body Diode Characteristics							
Continuous source-drain diode current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode	-	-	21	A	
Pulsed diode forward current	I <sub>SM</sub>		-	-	48		
Diode forward voltage	V <sub>SD</sub>	$T_J$ = 25 °C, $I_S$ = 11 A, $V_{GS}$ = 0 V	-	-	1.2	V	
Reverse recovery time	t <sub>rr</sub>	T 0500 H H H H	-	285	570	ns	
Reverse recovery charge	Q <sub>rr</sub>	T <sub>J</sub> = 25 °C, I <sub>F</sub> = I <sub>S</sub> = 11 A, di/dt = 100 A/µs, V <sub>B</sub> = 400 V	-	4.1	8.2	μC	
Reverse recovery current	I <sub>RRM</sub>		-	27	-	Α	

#### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ 



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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

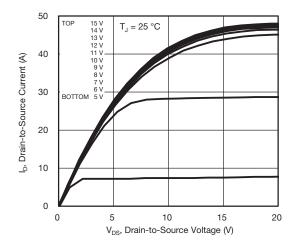
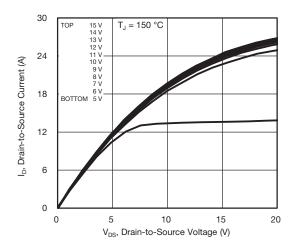
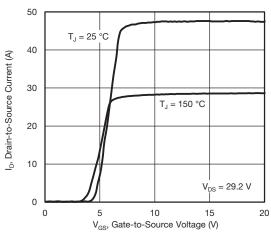


Fig. 1 - Typical Output Characteristics









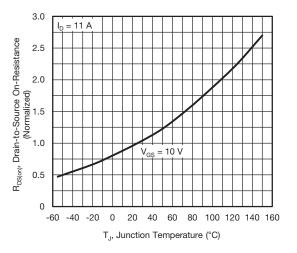


Fig. 4 - Normalized On-Resistance vs. Temperature

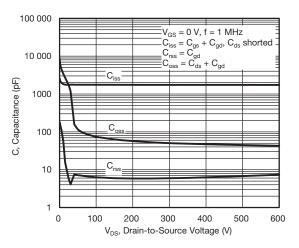


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

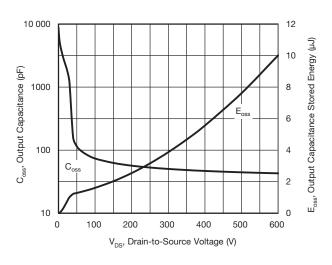


Fig. 6 -  $C_{\text{oss}}$  and  $E_{\text{oss}}$  vs.  $V_{\text{DS}}$ 

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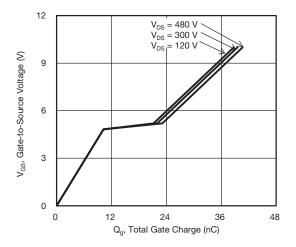


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

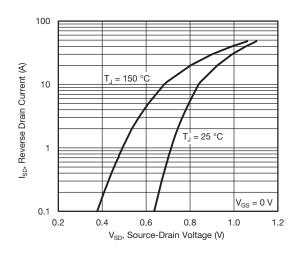


Fig. 8 - Typical Source-Drain Diode Forward Voltage

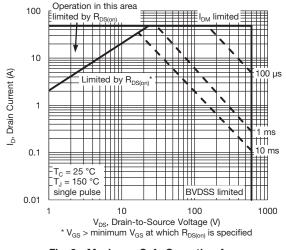


Fig. 9 - Maximum Safe Operating Area

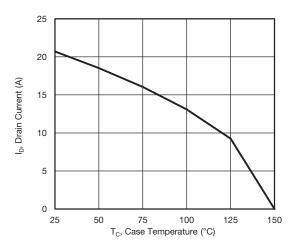


Fig. 10 - Maximum Drain Current vs. Case Temperature

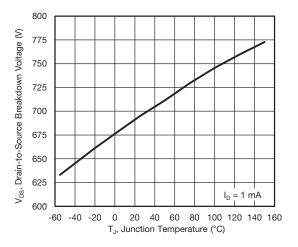


Fig. 11 - Temperature vs. Drain-to-Source Voltage

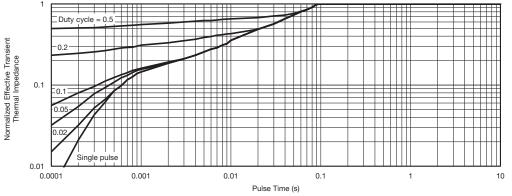
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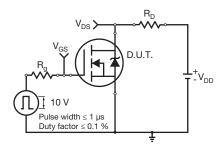


Fig. 13 - Switching Time Test Circuit

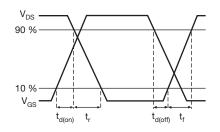


Fig. 14 - Switching Time Waveforms

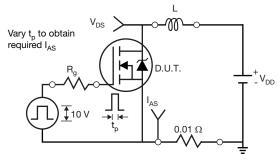


Fig. 15 - Unclamped Inductive Test Circuit

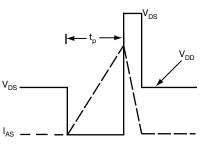


Fig. 16 - Unclamped Inductive Waveforms

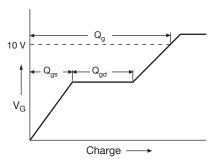


Fig. 17 - Basic Gate Charge Waveform

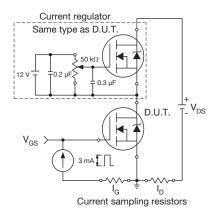


Fig. 18 - Gate Charge Test Circuit

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#### Peak Diode Recovery dV/dt Test Circuit

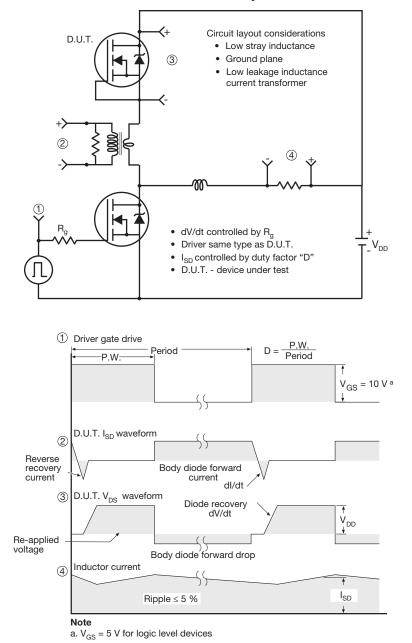


Fig. 19 - For N-Channel

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